

N-Ch 30V Fast Switching MOSFETs

- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

Product Summary



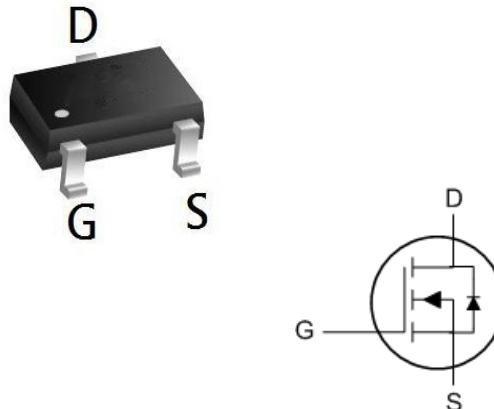
| BVDSS | RDS(on) | ID |
|-------|---------|------|
| 30V | 20mΩ | 6.0A |

Description

The XR3404AL is the high cell density trenched N-ch MOSFETs, which provides excellent RDS(on) and efficiency for most of the small power switching and load switch applications.

The XR3404AL meet the RoHS and Green Product requirement with full function reliability approved.

SOT23-3L Pin Configuration



Absolute Maximum Ratings

| Symbol | Parameter | Rating | Units |
|--------------------------------------|--|------------|-------|
| V _{DS} | Drain-Source Voltage | 30 | V |
| V _{GS} | Gate-Source Voltage | ±20 | V |
| I _D @T _A =25°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 6.0 | A |
| I _D @T _A =70°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 4.5 | A |
| I _{DM} | Pulsed Drain Current ² | 23.4 | A |
| P _D @T _A =25°C | Total Power Dissipation ³ | 1.6 | W |
| T _{STG} | Storage Temperature Range | -55 to 150 | °C |
| T _J | Operating Junction Temperature Range | -55 to 150 | °C |

Thermal Data

| Symbol | Parameter | Typ. | Max. | Unit |
|------------------|--|------|------|------|
| R _{θJA} | Thermal Resistance Junction-ambient ¹ | --- | 85 | °C/W |
| R _{θJC} | Thermal Resistance Junction-Case ¹ | --- | --- | °C/W |

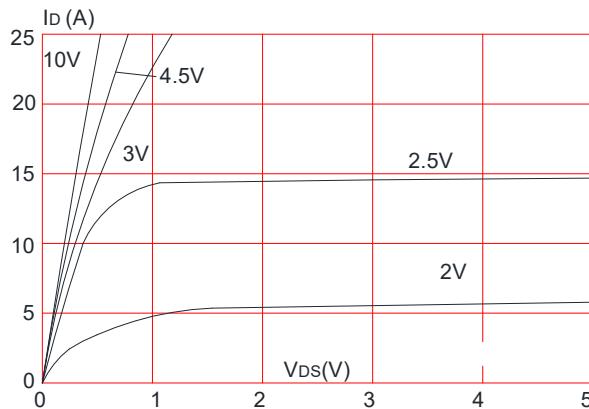
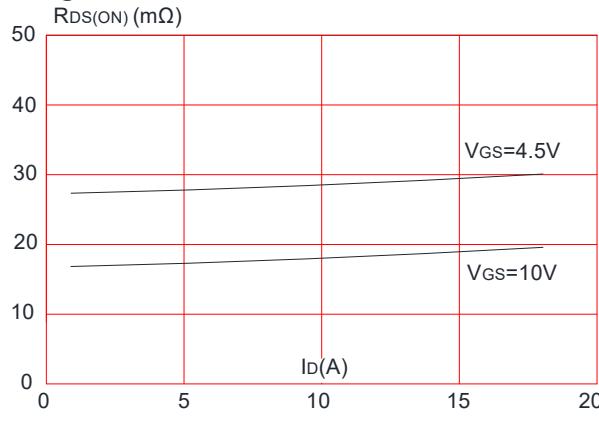
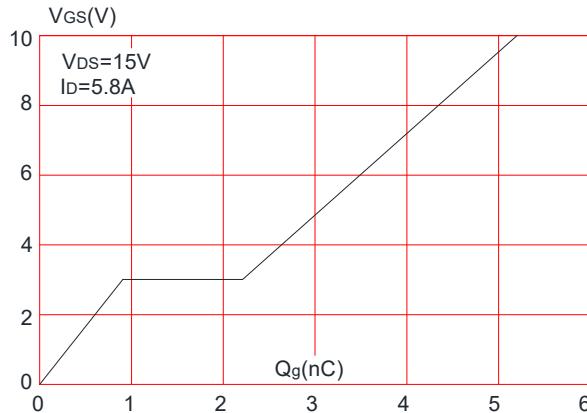
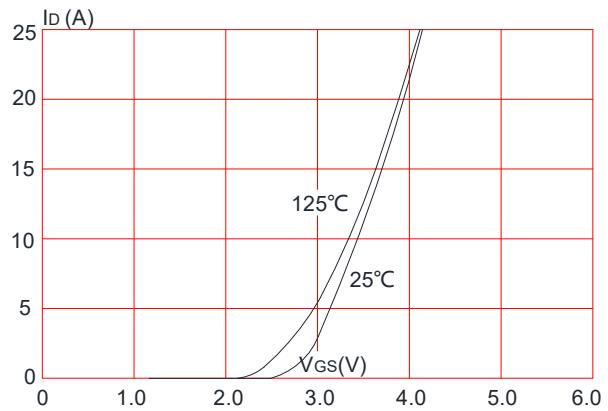
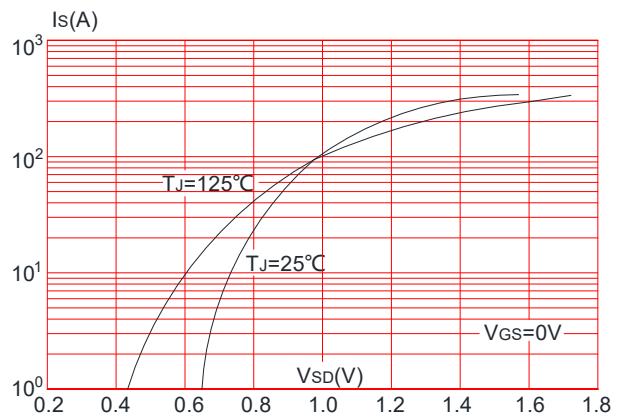
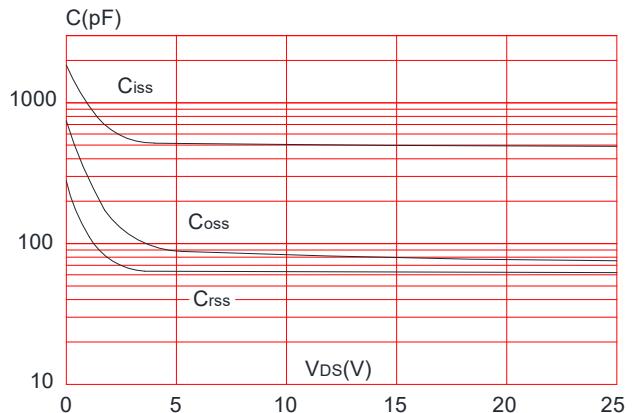
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Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

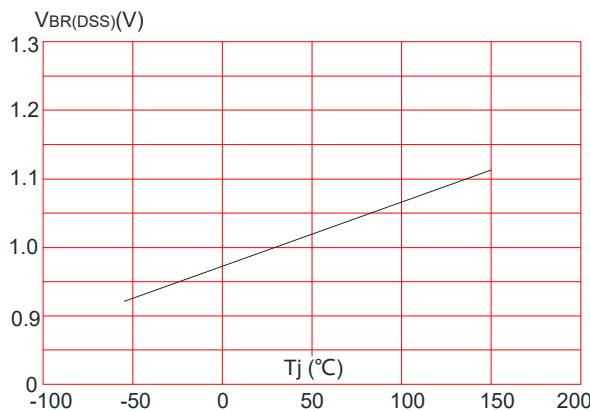
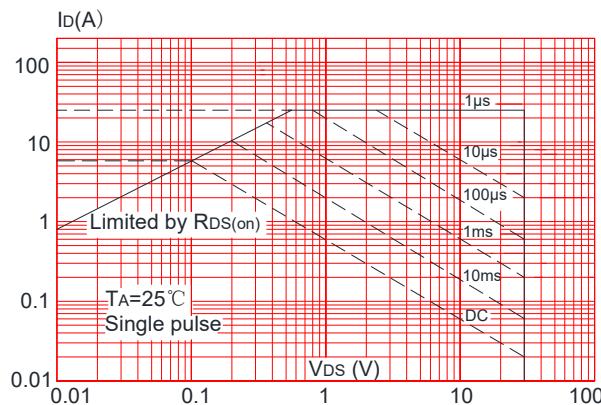
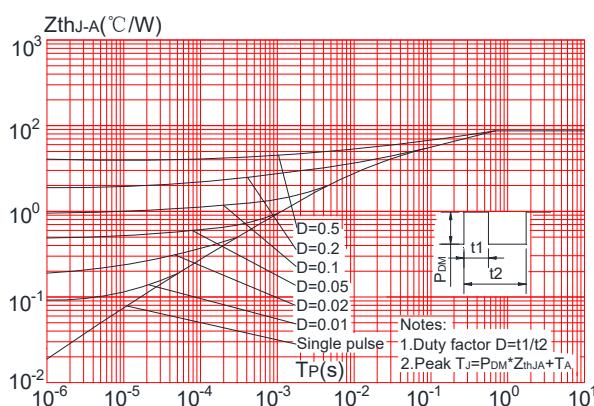
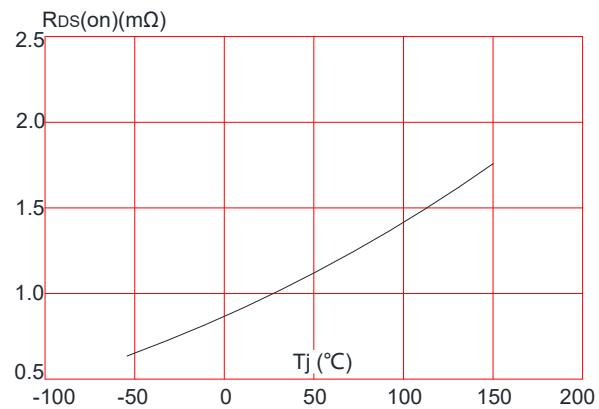
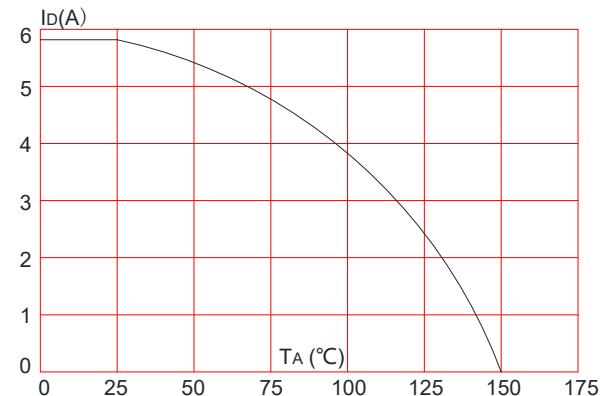
| Symbol | Parameter | Test Condition | Min. | Typ. | Max. | Units |
|---|--|---|------|------|-----------|------------------|
| Off Characteristic | | | | | | |
| $V_{(BR)DSS}$ | Drain-Source Breakdown Voltage | $V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$ | 30 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=30\text{V}$, $V_{GS}=0\text{V}$, | - | - | 1.0 | μA |
| I_{GSS} | Gate to Body Leakage Current | $V_{DS}=0\text{V}$, $V_{GS}=\pm 20\text{V}$ | - | - | ± 100 | nA |
| On Characteristics | | | | | | |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$ | 1.0 | 1.5 | 2.5 | V |
| $R_{DS(\text{on})}$ note2 | Static Drain-Source on-Resistance | $V_{GS}=10\text{V}$, $I_D=5.5\text{A}$ | - | 20 | 25 | $\text{m}\Omega$ |
| | | $V_{GS}=4.5\text{V}$, $I_D=4.5\text{A}$ | - | 28 | 40 | |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS}=15\text{V}$, $V_{GS}=0\text{V}$, $f=1.0\text{MHz}$ | - | 490 | - | pF |
| C_{oss} | Output Capacitance | | - | 79 | - | pF |
| C_{rss} | Reverse Transfer Capacitance | | - | 61 | - | pF |
| Q_g | Total Gate Charge | $V_{DS}=15\text{V}$, $I_D=5.8\text{A}$, $V_{GS}=10\text{V}$ | - | 5.2 | - | nC |
| Q_{gs} | Gate-Source Charge | | - | 0.9 | - | nC |
| Q_{gd} | Gate-Drain("Miller") Charge | | - | 1.3 | - | nC |
| Switching Characteristics | | | | | | |
| $t_{d(on)}$ | Turn-on Delay Time | $V_{DS}=15\text{V}$, $I_D=3\text{A}$, $R_{GEN}=3\Omega$, $V_{GS}=10\text{V}$ | - | 4.5 | - | ns |
| t_r | Turn-on Rise Time | | - | 2.5 | - | ns |
| $t_{d(off)}$ | Turn-off Delay Time | | - | 14.5 | - | ns |
| t_f | Turn-off Fall Time | | - | 3.5 | - | ns |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| I_S | Maximum Continuous Drain to Source Diode Forward Current | - | - | 6.0 | A | |
| I_{SM} | Maximum Pulsed Drain to Source Diode Forward Current | - | - | 23.2 | A | |
| V_{SD} | Drain to Source Diode Forward Voltage | $V_{GS}=0\text{V}$, $I_S=5.8\text{A}$ | - | - | 1.2 | V |

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

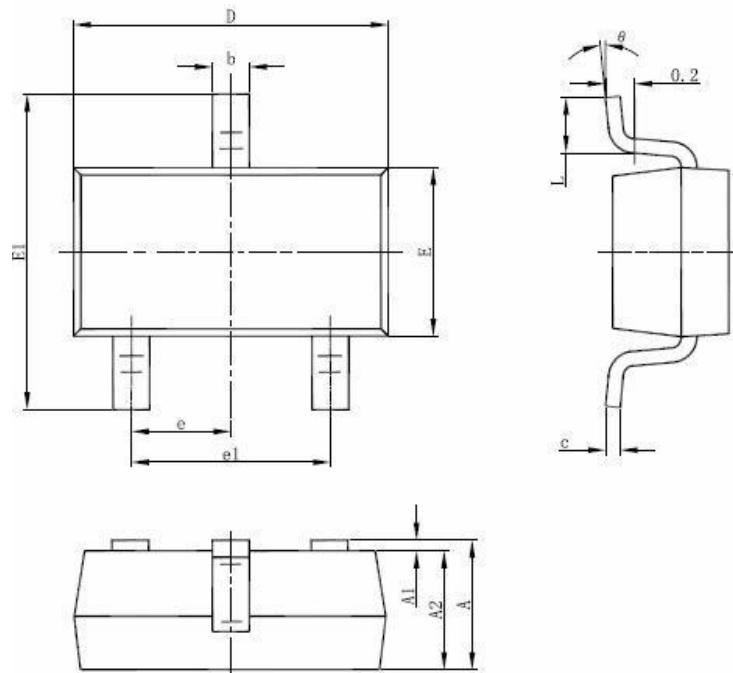
2. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$

N-Ch 30V Fast Switching MOSFETs**Figure 1:** Output Characteristics**Figure 3:** On-resistance vs. Drain Current**Figure 5:** Gate Charge Characteristics**Figure 2:** Typical Transfer Characteristics**Figure 4:** Body Diode Characteristics**Figure 6:** Capacitance Characteristics

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Figure 7: Normalized Breakdown Voltage vs. Junction Temperature**Figure 9:** Maximum Safe Operating Area**Figure 11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient**Figure 8:** Normalized on Resistance vs. Junction Temperature**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature

SOT-23-3L Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 1.050 | 1.250 | 0.041 | 0.049 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 1.050 | 1.150 | 0.041 | 0.045 |
| b | 0.300 | 0.500 | 0.012 | 0.020 |
| c | 0.100 | 0.200 | 0.004 | 0.008 |
| D | 2.820 | 3.020 | 0.111 | 0.119 |
| E | 1.500 | 1.700 | 0.059 | 0.067 |
| E1 | 2.650 | 2.950 | 0.104 | 0.116 |
| e | 0.950(BSC) | | 0.037(BSC) | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.300 | 0.600 | 0.012 | 0.024 |
| θ | 0° | 8° | 0° | 8° |